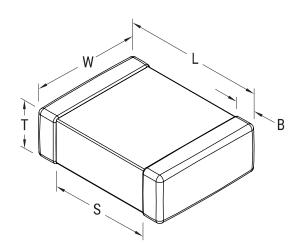


C0603C330J8RACTU

Aliases (C0603C330J8RAC7867) SMD Comm X7R, Ceramic, 33 pF, 5%, 10 VDC, X7R, SMD, MLCC, Temperature Stable, Class II, 0603, 0.5 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X7R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	4.8 mg
Shelf Life	78 Weeks
MSL	1

Dimensions		S
Chip Size	0603	C
L	1.6mm +/-0.15mm	М
W	0.8mm +/-0.15mm	Тс
т	0.8mm +/-0.07mm	V
S	0.5mm MIN	D
В	0.35mm +/-0.15mm	Te
		т.

Packaging Specifications

Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	4000

Specifications	
Capacitance	33 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	5%
Voltage DC	10 VDC
Dielectric Withstanding Voltage	25 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	5%1kHz1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 48 Hours
Insulation Resistance	100 GOhms

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